



**SUPER FAST DIODE MODULE TYPE
100A / 200V**

Features

- High Surge Capability
- Type 200V V_{RRM}

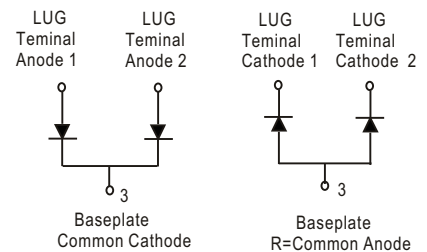
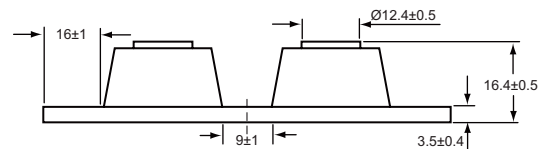
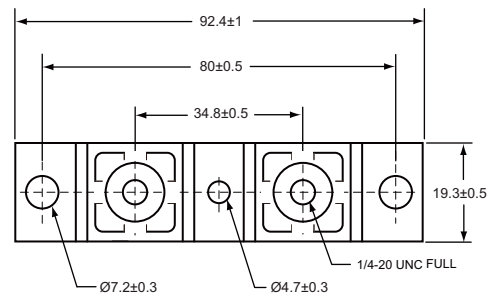
Maximum Ratings

- Junction Operating Temperature : -55°C to $+175^{\circ}\text{C}$
- Storage Temperature : -55°C to $+175^{\circ}\text{C}$



| Part Number | Maximum Recurrent Peak Reverse Voltage | Maximum RMS Voltage | Maximum DC Blocking Voltage |
|---------------|--|---------------------|-----------------------------|
| MUR10020CT(R) | 200V | 140V | 200V |

Dimensions in mm (1 mm = 0.0394")



Electrical Characteristics @ 25 °C Unless Otherwise Specified

| | | | |
|---|-----------------|--|---|
| Average Forward Current (Per pkg) | $I_{F(AV)}$ | 100A | $T_C = 140^{\circ}\text{C}$ |
| Peak Forward Surge Current (Per diode) | I_{FSM} | 1500A | 8.3ms, half sine |
| Maximum Instantaneous Forward Voltage* (Per diode) | V_F | 1.0V | $I_{FM} = 50A$; $T_J = 25^{\circ}\text{C}$ |
| Maximum Instantaneous Reverse Current At Rated DC Blocking Voltage* (Per diode) | I_R | 25µA 3mA | $T_J = 25^{\circ}\text{C}$ $T_J = 125^{\circ}\text{C}$ |
| Maximum Reverse Recovery Time (Per diode) | T_{rr} | 75ns | $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$ |
| Maximum Thermal Resistance Junction To Case (Per diode) | $R_{\theta jc}$ | 1.0 °C/W | |
| Mounting torque | | 35-40 In-lb 30-40 In-lb 8-10 In-lb | Terminal torque Outside holes Center hole |
| Weight | | 84g | |

*Pulse Test : Pulse Width 300 µsec, Duty Cycle 2%



Figure .1- Typical Forward Characteristics

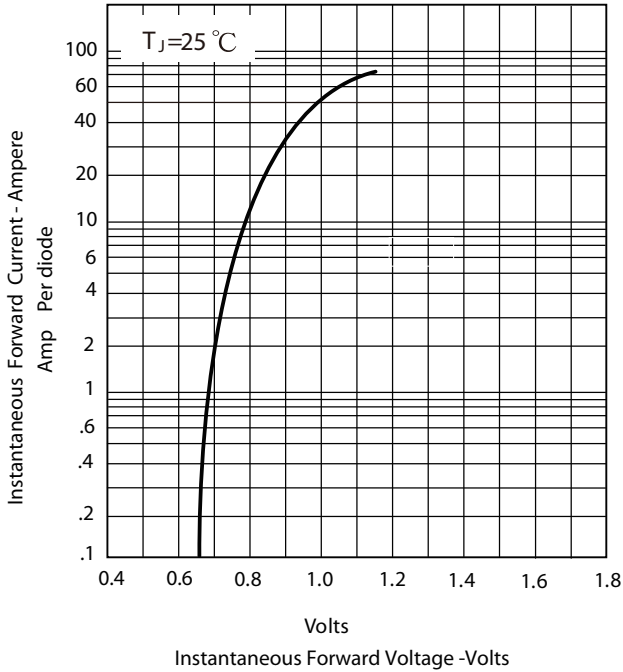


Figure .2- Forward Derating Curve

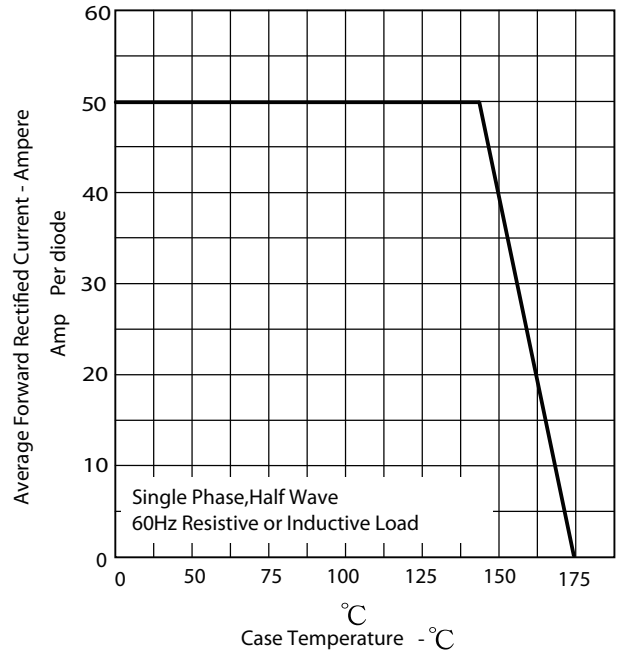


Figure.3- Peak Forward Surge Current

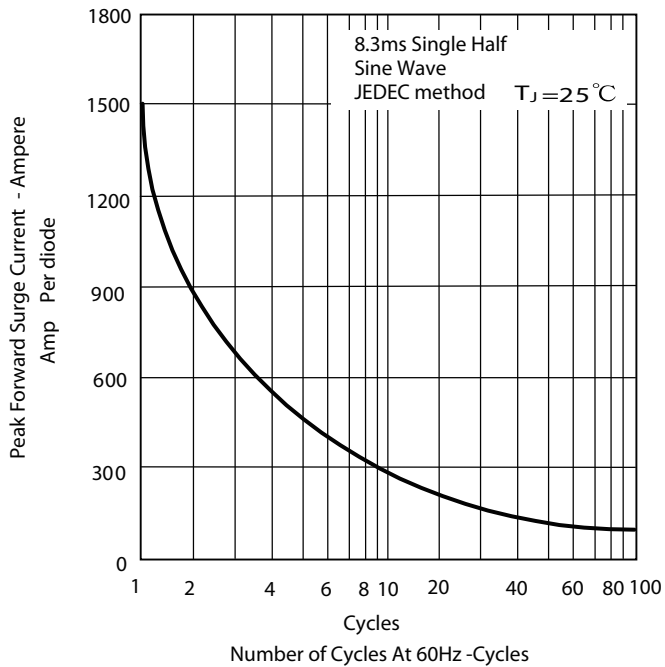
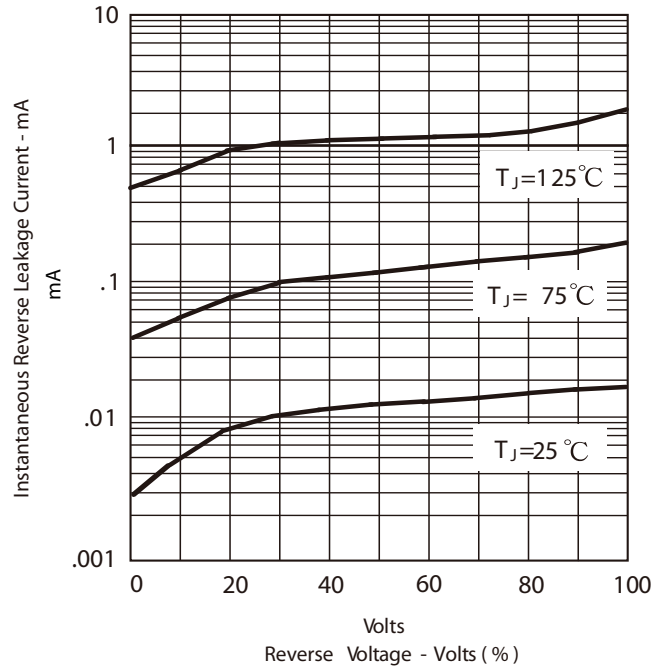


Figure .4 -Typical Reverse Characteristics





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